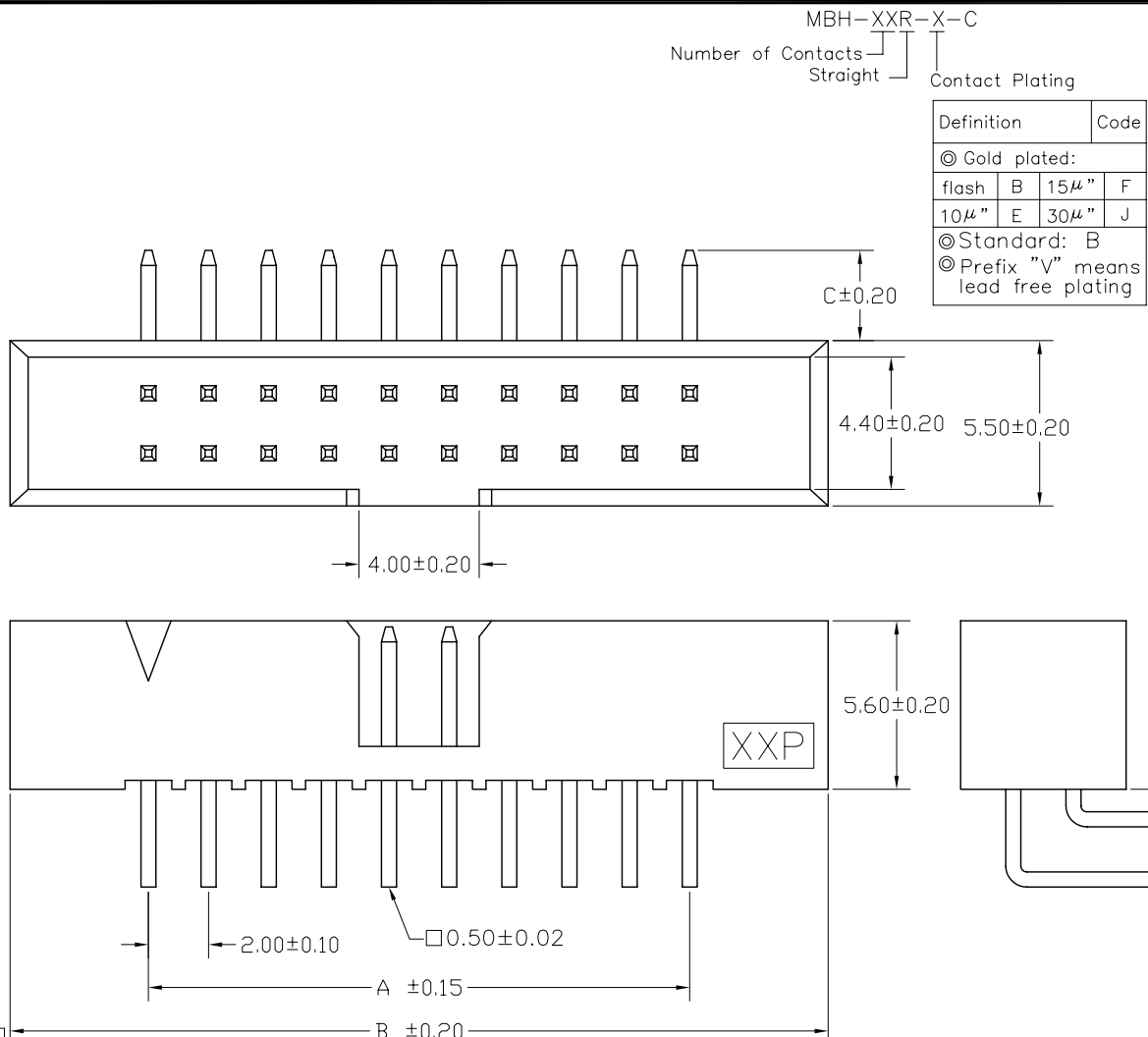


No. of Contacts	DIMENSIONS		REMARK (無導)
	A	B	
6	4.00	13.20	○
8	6.00	15.20	○
10	8.00	17.20	○
12	10.00	19.20	○
14	12.00	21.20	○
16	14.00	23.20	○
18	16.00	25.20	○
20	18.00	27.20	○
22	20.00	29.20	○
24	22.00	31.20	○
26	24.00	33.20	○
30	28.00	37.20	○
32	30.00	39.20	
34	32.00	41.20	○
36	34.00	43.20	○
40	38.00	47.20	○
44	42.00	51.20	○
50	48.00	57.20	○
56	54.00	63.20	○
60	60.00	67.20	○
68	68.00	75.20	○



Definition	Code
◎ Gold plated:	
flash B 15μ"	F
10μ" E 30μ"	J
◎ Standard: B	
◎ Prefix "V" means lead free plating	

**SPECIFICATIONS**

Current Rating: 1 Amp  
 Insulator resistance: 5000 Megohms min.  
 Dielectric withstanding: AC 500 V  
 Operating Temperature: -40° - +105°C  
 Contact Material: Copper alloy  
 Insulator Material: High Temperature Thermoplastic, UL 94V-0 (Nylon-6T)  
 Color: Black  
 Finish: Tin, Gold or Duplex plated  
 ◎ Note: Duplex plating: gold plated on contact area, Tin on solder area  
 ◎ For illustration purpose the MBH-XXR-X-027 was shown  
 Recommended PCB Layout (PCB TOLERANCE ±0.05)

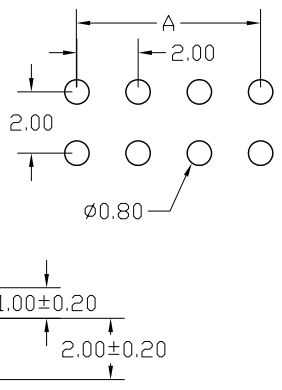


Diagram	Molding description
○	mass production & assemble mold
◎	sample & assemble mold
⊕	mass production & fix mold
⊕	sample & fix mold

PARTS NO.	C	REMARK (備註)
MBH-XXR-X-027	2.70	○
MBH-XXR-X-020	2.00	

Rev.	ECN Number	Description	Drawn	Date
3	EC2-4C0512	Revise remark	Lydia Hong	12/29 04'
4	ECR-530081	增加倒角結構	陳顯鑫	03/29 05'
5	ECR-560227	新增 MBH-XXR-X-020	陳顯鑫	06/28 05'



GENERAL TOLERANCE		SCALE
XX. ± 0.50	XXX. ±	4 = 1
X. ± 0.30	.XXX ±	UNIT MM
.X ± 0.25	X.° ± 4°	SIZE A4
.XX ± 0.20	.X° ± 4°	

ORIGINAL DRAWN	DATE
Funny,Chiu	11/05 04'
CHECK	DATE
Lyndon.Lin	06/28 05'
APPROVE	DATE
Lyndon.Lin	06/28 05'

DWG. NO.	TITLE	REV.
X-XX F:\DWG\CDWG\MBH\MBHROA	2.0x2.0mm BOX HEADER (成品規格圖)	5
PARTS NO.	SHEET	
MBH-XXR-X-C	1/1	